# MICROCHIP

# MX554EBC180M000

### Ultra-Low Jitter 180MHz LVCMOS XO

#### ClockWorks® FUSION

# **General Description**

The MX554EBC180M000 is an ultra-low phase jitter XO with LVCMOS output optimized for high line rate applications.

#### **Features**

- 180MHz LVCMOS
- Typical phase noise:
  - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

# Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T <sub>c</sub> )	65°C to +125°C
Storage Temperature (T <sub>S</sub> ) ESD Machine Model	200V
ESD Rating (HBM)	2kV

# Operating Ratings<sup>2</sup>

Supply Voltage (VIN)	+2.375V to $+3.63V$
Ambient Temperature (TA)	40°C to $+85$ °C
Junction Thermal Resistance	
LGA (T <sub>IA</sub> ) Still Air	58°C/W
` JA´	

## **Electrical Characteristics**

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, output terminated with 50 Ohms to VDD/2.3

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			180		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		500	ps
	Duty Cycle		45		55	%
VIH	Input High Voltage	3.3V Operation	2		VDD + 0.3	V
VIL	Input Low Voltage	3.3V Operation	-0.3		0.8	V
VOH	Output High Voltage	LVCMOS output levels	VDD - 0.8			V
VOL	Output Low Voltage	LVCMOS output levels			0.6	V

#### Notes

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- 3. Guaranteed after thermal equilibrium.
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

ClockWorks is a registered trademark of Microchip Technology Inc.

Microchip Technology Inc. http://www.microchip.com

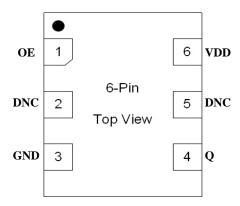
September 19, 2019 MX554EB1-8284 Revision 1.0 tcghelp@microchip.com

# **Ordering Information**

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554EBC180M000	MX554E	BC1800	Tube	6-Pin 5mm x 3.2mm LGA
MX554EBC180M000-TR	MX554E	BC1800	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

# **Pin Configuration**



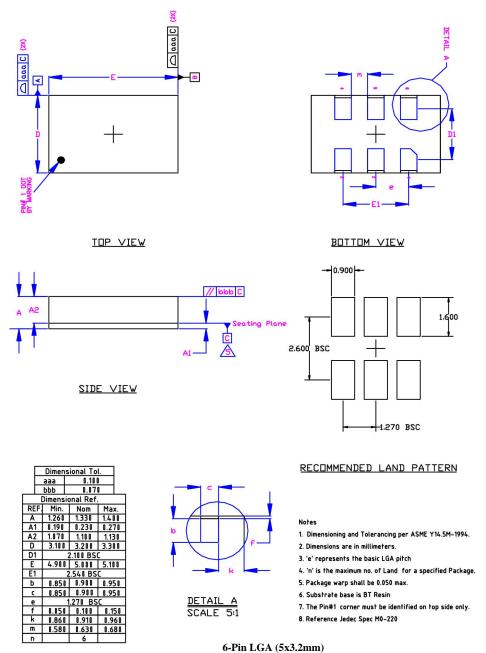
# **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, DNC	O, SE	LVCMOS	Clock Output Frequency = 180MHz
6	VDD	PWR		Power Supply

# **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A	
Moisture Resistance	MIL-STD-883, Method 1004	
Mechanical Shock	MIL-STD-883, Method 2002, Condition E	
Mechanical Vibration	MIL-STD-883, Method 2007, Condition C	
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)	
Hazardous Substance	Pb-Free / RoHS / Green Compliant	
Solderability	JESD22-B102-D Method 2 (Preconditioning E)	
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D	
Gross Leak	MIL-STD-883, Method 1014, Condition C	
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s	
Solvent Resistance	MIL-STD-202, Method 215	

## Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



#### Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

## Microchip Technology Inc.

## http://www.microchip.com

Microchip makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Microchip does not assume responsibility for its use. Microchip reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Microchip's terms and conditions of sale for such products, Microchip assumes no liability whatsoever, and Microchip disclaims any express or implied warranty relating to the sale and/or use of Microchip products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

© 2019 Microchip Technology Inc.